## Sensing Device

## **GYRO SENSOR (Digital Output)**

## **XV7081BB**

- Excellent bias temperature coefficient 0.0024 (°/s)/°C Typ.
- Low angle random walk 0.065 °/√h Typ.
- SPI or I<sup>2</sup>C serial interface
- · Integrated user-selectable digital filter
- Angular rate output (16 bits or 24 bits resolution)
- Operating temperature -20 °C to +80 °C
- Embedded temperature sensor
- Low current consumption 900 µA Typ.

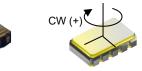
### **Recommended Application**

- · Anti-vibration, attitude control for industrial applications.
- · Autonomous machines . . . . .
  - \*The I<sup>2</sup>C-Bus is a trademark of NXP Semiconductors



Product number XV7081BB: X2A000351xxxx00

SEIKO EPSON CORPORATION



Item	Symbol	Specifications	Conditions / Remarks
Supply voltage	V <sub>DDM</sub>	2.7 V to 3.6 V	
Supply voltage for interface	V <sub>DDI</sub>	1.65 V to 3.6 V	
Storage temperature	T <sub>STG</sub>	-40 °C to +85 °C	
Operating temperature	T <sub>OPR</sub>	-20 °C to +80 °C	
Scale factor	S <sub>o</sub>	70 LSB/(°/s) ±2 %	16 bits, T <sub>a</sub> = +25 °C
		17920 LSB/(°/s) ±2 %	24 bits, T <sub>a</sub> = +25 °C
Scale factor variation over temperature	Sp	±3.0 %	V <sub>DDM</sub> = 3 V, T <sub>a</sub> = +25 °C reference
Bias	ZRL	±1 °/s (0 LSB Typ.)	T <sub>a</sub> = +25 °C
Bias variation over temperature	ZRLt	±3.0 °/s	V <sub>DDM</sub> = 3 V, T <sub>a</sub> = +25 °C reference
Bias temperature coefficient	ZRLs	0.0024 (°/s)/°C Typ.	$V_{DDM}$ = 3 V, Average of absolute value, $\Delta$ = 1 °C.
Rate range	I	±400 °/s	
Non-linearity	NI	±0.5 %FS	T <sub>a</sub> = +25 °C
Cross-axis sensitivity	CS	±5 %	T <sub>a</sub> = +25 °C
Current consumption	I <sub>op1</sub>	900 µA Typ.	
Stand-by current	I <sub>op2</sub>	160 μA Typ.	
Sleep current	I <sub>op3</sub>	3 µA Typ.	
Noise density	N <sub>d</sub>	0.0015 (⁰/s)/√Hz	@ 10Hz, LPF default setting
Angle random walk	N	0.065 °/√h	

Product Name (Standard form) <u>XV708 1 B B</u> \* \* 1 234 56

① Model

2 Detection axis (1: Z axis) ④ Output (B: SPI/I<sup>2</sup>C) 5 Frequency

③ Package type (B: Ceramics 5032 size) 6 Custom recognition (not necessary to specify)

#### Footprint (Recommended) External Dimensions (Unit: mm) (Unit: mm) #10 #9 #8 #7 #6 E V7081BC **3.2**<sup>±0.2</sup> 0 HL871C 0.7 #1 #2 #3 #4 #5 5.0<sup>±0.2</sup> Pin map 3<sup>±0.2</sup> Pin Connection 1.2 MOSI/SDA 1 2 SS 0.32 3 VDDL 4 Reserved1 5 GND 6 $V_{\text{DDM}}$ Reserved2 7 V<sub>DDI</sub> MISO/SA0 8 9 10 SCLK/SCL Connect "Reserved1" pin to GND. 0.6 Do not connect "Reserved2" pin externally.

# PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

## WORKING FOR HIGH QUALITY

In order provide high quality and reliable products and services than meet customer needs, Seiko Epson made early efforts towards obtaining ISO9000 series certification and has acquired ISO9001 for all business establishments in Japan and abroad. We have also acquired IATF 16949 certification that is requested strongly by major automotive manufacturers as standard.

Explanation of the mark that are using it for the catalog

ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.

IATF 16949 is the international standard that added the sector-specific supplemental requirements for automotive industry based on ISO9001.

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For Automotive	► Designed for automotive applications such as Car Multimedia, Body Electronics, Remote Keyless Entry etc.
Automotive Safety	► Designed for automotive applications related to driving safety (Engine Control Unit, Air Bag, ESC etc ).

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Other applications requiring similar levels of reliability as the above

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